

ISSUE : May 11, 2017

TO ; _____

S P E C I F I C A T I O N S

Product Name SOLID STATE RELAYModel No. R39MF5

【Business dealing name : PR39MF51NSLH】

These specifications contain 12 pages including the cover and appendix.
This specification sheets and attached sheets shall be both side copy.
After confirmation of the contents, please be sure to send back copy of the
Specifications with approving signature on each.
If you have any objections, please contact us before issuing purchasing order.

Accepted by:

By : _____

Name :

Title :

Date :

By : _____

Name :

Title :

Date :

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Title : Division Manager,

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Semiconductor Business Unit

Electronic Components and Devices BU

Date : May. 11, 2017

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Date : May. 11, 2017

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Date : May 11, 2017

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2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below.
Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas ;
 - Computers • OA equipment • Telecommunication equipment (Terminal) • Measuring equipment
 - Tooling machines • Audio visual equipment • Home appliancesIf the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.
- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals • Gas leakage sensor breakers • Rescue and security equipment
 - Other safety equipment
- (4) Sharp product is designed for consumer goods and controlled as consumer goods in production and quality.
Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;
 - Space equipment • Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment • Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.

3. Disclaimer

The warranty period for Sharp product is one (1) year after shipment.
During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund.
Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer.
Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by:

- (1) storage keep trouble during the inventory in the marketing channel.
- (2) intentional act, negligence or wrong/poor handling.
- (3) equipment which Sharp products are connected to or mounted in.
- (4) disassembling, reforming or changing Sharp products.
- (5) installation problem.
- (6) act of God or other disaster (natural disaster, fire, flood, etc.)
- (7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)
- (8) special environment (factory, coastal areas, hotspring area, etc.)
- (9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.
- (10) the factors not included in the product specification sheet.

4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

1. Application

This specification applies to the outline and characteristics of Solid State Relay (SSR),
Model No. R39MF5 [Apply line voltage 200V AC(sine wave)].

2. Outline

Refer to the attached sheet, page 5.

3. Ratings and characteristics

Refer to the attached sheet, page 6 to 7.

4. Reliability

Refer to the attached sheet, page 8.

5. Outgoing inspection

Refer to the attached sheet, page 9.

6. Supplement

6.1 Business dealing name

The business dealing name used for this product when ordered or delivered shall be PR39MF51NSLH

6.2 Package specification

Refer to the attached sheet, page 10 to 11.

6.3 Isolation voltage shall be measured in the following method.


- (1) Short between anode and cathode on the primary side and between T₁, T₂ and gate on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL and CSA. (Under preparation)

Approved Model No. : R39MF5

1. UL file No. : E94758

2. CSA approved mark "  " and rating shall be indicated on minimum unit package.

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1,1,1-Trichloroethane (Methyl chloroform)

6.7 Brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.

6.8 Compliance with each regulation

6.8.1 The RoHS directive(2011/65/EU)

This product complies with the RoHS directive(2011/65/EU) .

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB)
and polybrominated diphenyl ethers (PBDE)

6.8.2 Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic

Information Products Regulation (Chinese : 电子信息产品污染控制管理办法).

Marking Styles for the Names and Contents of the Hazardous Substances

Category	Hazardous Substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Solid State Relay	×	○	○	○	○	○

This table is prepared in accordance with the provisions of SJ/T 11364.

- : Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572
- × : Indicates that said hazardous substance contained in at least one of the homogeneous materials used for this part is above the limit requirement of GB/T 26572

The marking "×" in the above table indicates the exemption of RoHS directive (2011/65/EU), where the elimination or substitution of the restrictive substances is still immature technically and impracticable economically from a current scientific view.

7. Notes

7.1 Circuit designing

(1) Trigger current

The LED used in the Solid State Relay generally decreases the light emission power by operation.

In case of long operation time, please decide I_F value so that I_F is twice or more of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)

(2) Snubber circuit

This device doesn't have built-in snubber circuit.

To avoid the false operation and protect SSR, please locate the appropriate snubber circuit between output pins base by the load. (Recommendable values : $R_s=47\Omega$, $C_s=0.022\mu F$)

Particularly, in case the device is used for the load such as solenoid valves and motors, false operation may happen in off-state due to rapid change of voltage at output pins caused by the phase difference of load current.

So please be sure to locate the snubber circuit ($R_s=47\Omega$, $C_s=0.022\mu F$) and make sure the device works properly in actual conditions.

In addition, the values of snubber circuit may have to be changed if necessary after tested in actual conditions.

(3) Off-state input current

Input current (I_F) at off-state shall be set 0.1mA or less.

(4) In case that pulse drive is carried out, it shall be recommended to use that the pulse width of input signal is 1ms or more.

(5) Pulse drive

In case that pulse drive is carried out, the pulse width of input signal should be 1ms or more.

(6) If the voltage exceeding the repetitive peak off-state voltage (V_{DRM}) in the absolute maximum ratings is applied to the phototriac, it may cause not only faulty operation but breakdown.

Make sure that the surge voltage exceeding V_{DRM} shall not be applied by using the varistor, CR.

7.2 Cleaning

(1) Solvent cleaning : Solvent temperature 45°C or less Immersion for 3 min or less

(2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that any defect doesn't occur before starting the ultrasonic cleaning.

(3) Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

In case the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

7.3 Using method

As to this product, all pin shall be used by soldering on the print wiring board. (Socket and others shall not be used.)

7.4 Precautions for Soldering

(1) In case of flow soldering

It is recommended that flow soldering be carried out at 270°C or less and within 10s

(Pre-heating: 100 to 150°C, 30 to 80s) : Within 2 times

(2) In case of hand soldering

It is recommended that hand soldering be carried out at 400°C or less and within 3s: Within 2 times

(3) Other precautions

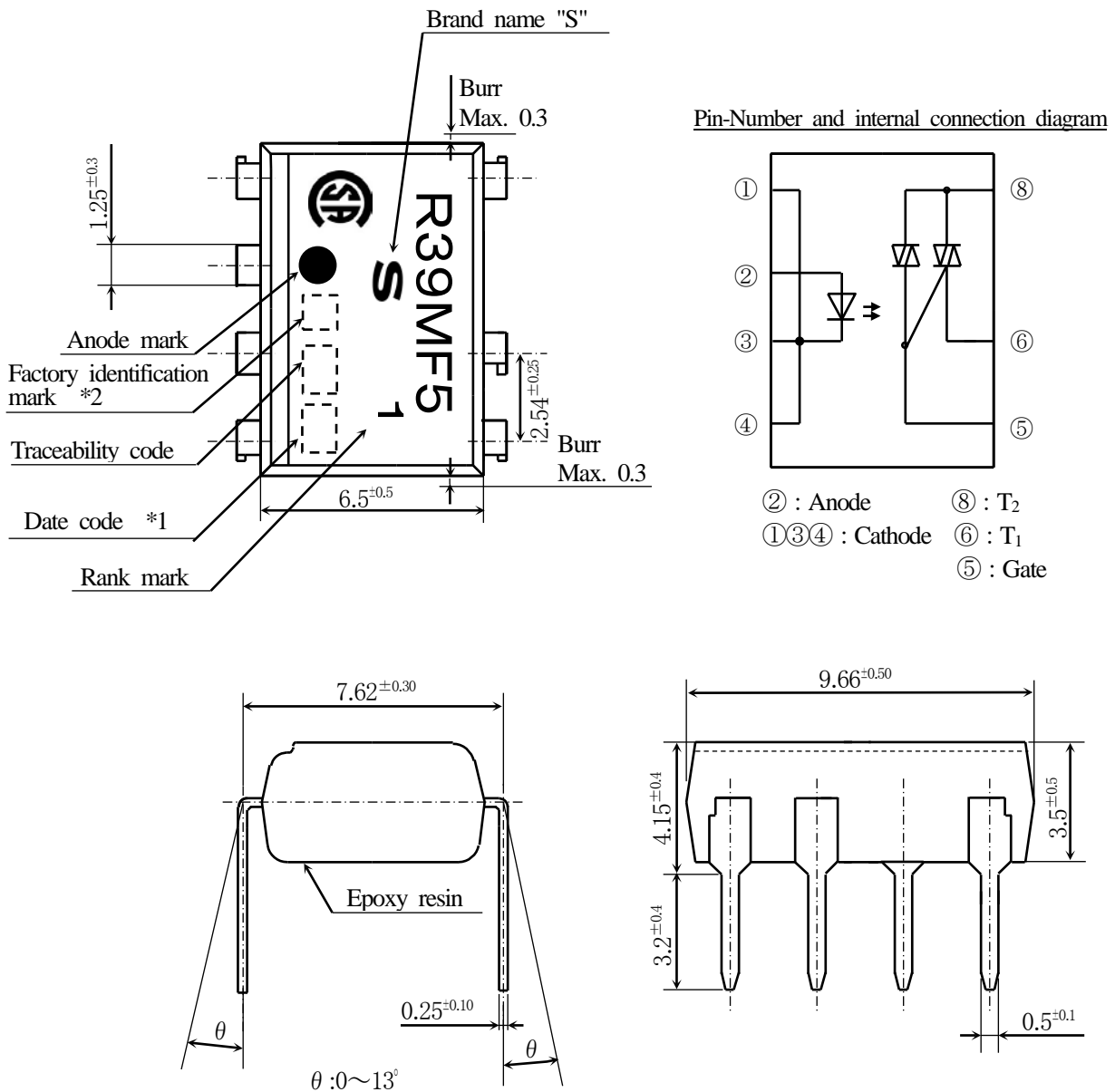
Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.

(Notice)

The contents described herein are subject to change without notice for improvement since this product is under development.

2. Outline



*1) Date code : 3 digit indication according to production year and week

*2) Factory identification mark applies to the below.

K : Kyushu Denshi Co., Ltd. (Japan product)

Product mass : Approx. 0.55g

Pin material : Copper Alloy

Pin finish : SnBi plating (Bi : 1~4%)

Mark : laser marking

UNIT : 1/1 mm

Name

R39MF5 Outline Dimensions
(Business dealing name : PR39MF51NSLH)

3. Ratings and characteristics

3.1 Absolute maximum ratings

 $T_a=25^{\circ}\text{C}$

Parameter		Symbol	Rating	Unit
Input	Forward current *1	I_F	50	mA
	Reverse voltage	V_R	6	V
Output	RMS on-state current *1	$I_T(\text{rms})$	0.9	A
	Peak one cycle surge current	I_{surge}	9 (50Hz sine wave)	A
	Repetitive peak off-state voltage	V_{DRM}	600	V
Isolation voltage *2		$V_{\text{iso}}(\text{rms})$	4.0	kV
Operating temperature		T_{opr}	-30 to +85	$^{\circ}\text{C}$
Storage temperature		T_{stg}	-40 to +125	$^{\circ}\text{C}$
Soldering temperature		T_{sol}	270 (For 10s)	$^{\circ}\text{C}$

*1 The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

*2 AC for 1min, 40 to 60%RH, $f=60\text{Hz}$

3.2 Electrical characteristics

 $T_a=25^{\circ}\text{C}$

Parameter		Symbol	MIN.	TYP.	MAX.	Unit	Conditions
Input	Forward voltage	V_F	-	1.2	1.4	V	$I_F=20\text{mA}$
	Reverse current	I_R	-	-	10	μA	$V_R=3\text{V}$
Output	Repetitive peak off-state current	I_{DRM}	-	-	100	μA	$V_D=V_{\text{DRM}}$
	On-state voltage	V_T	-	-	2.5	V	$I_T=0.9\text{A}$
	Holding current	I_H	-	-	25	mA	$V_D=6\text{V}$
	Critical rate of rise of off-state voltage	dv/dt	100	-	-	$\text{V}/\mu\text{s}$	$V_D=(1/\sqrt{2}) \cdot V_{\text{DRM}}$
	Minimum trigger current	I_{FT}	-	-	10	mA	$V_D=6\text{V}, R_L=100\Omega$
Transfer characteristics	Isolation resistance	R_{ISO}	5×10^{10}	10^{11}	-	Ω	DC500V 40 to 60%RH
	Turn on time	t_{ON}	-	-	100	μs	$V_D=6\text{V}, R_L=100\Omega, I_F=20\text{mA}$

Fig.1 Forward current vs. ambient temperature

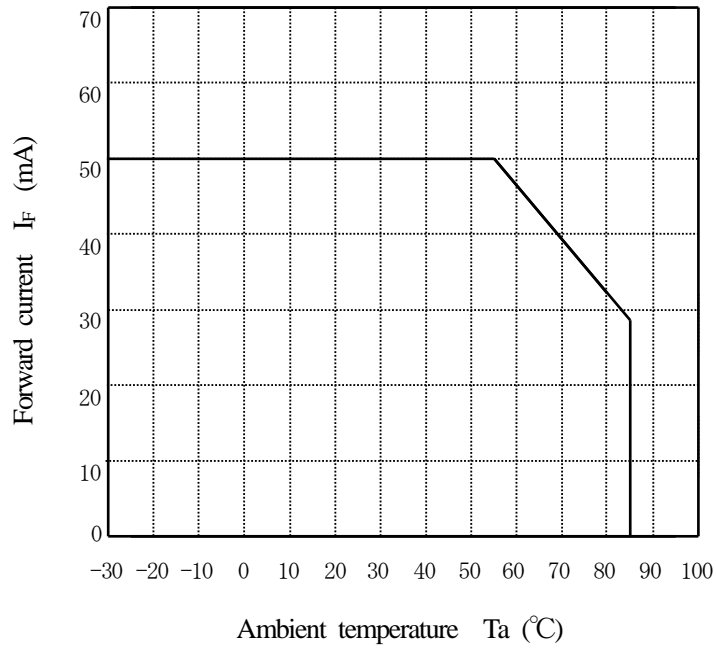
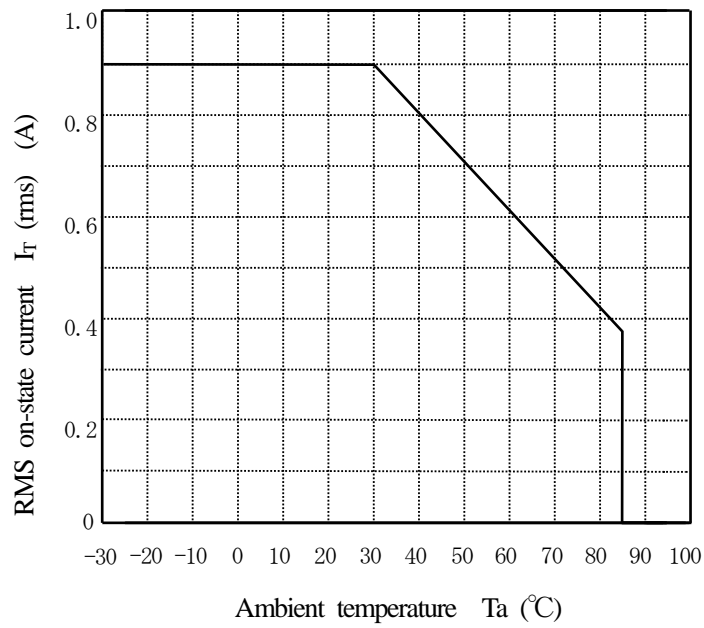


Fig.2 RMS on-state current vs. ambient temperature



4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level : 90%

LTPD : 10 or 20

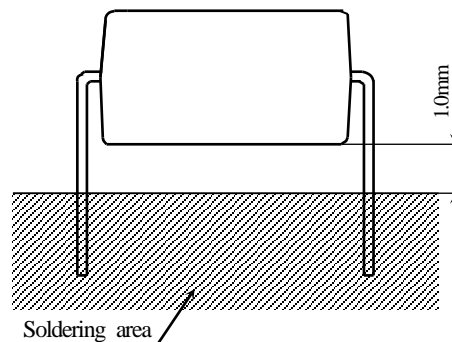
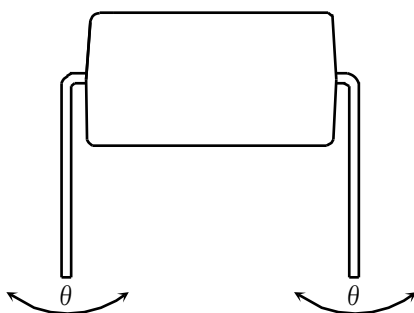
Test Items	Test Conditions *1	Failure Judgement Criteria	Samples (n)
			Defective(C)
Solderability	245±3°C, 5s	*2	n=11, C=0
Soldering heat *3	(Flow soldering) 270°C, 10 s	$V_F > U \times 1.2$ $V_T > U \times 1.2$ $I_{FT} > U \times 1.3$ $I_R > U \times 2.0$ $I_{DRM} > U \times 2.0$ U : Upper specification limit	n=11, C=0
	(Soldering by hand) 400°C, 3 s		n=11, C=0
Terminal strength (Tension)	Weight : 5N 5 s/each terminal		n=11, C=0
Terminal strength (Bending) *4	Weight : 2.5N 2 times/each terminal		n=11, C=0
Mechanical shock	15km/s ² , 0.5ms 3 times/±X, ±Y, ±Z direction		n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction		n=11, C=0
Temperature cycling	1 cycle -40°C to +125°C (30min) (30min) 20 cycles test, Without Road		n=22, C=0
High temp. and high humidity storage	+60°C, 90%RH, 500h		n=22, C=0
High temp. storage	+125°C, 1000h		n=22, C=0
Low temp. storage	-40°C, 1000h		n=22, C=0
Operation life	I _F =50mA, I _T (rms)=0.9A Ta=25°C, 1000h		n=22, C=0

*1 Test method, conforms to EIAJ ED 4701.

*2 The product whose not-soldered area is more than 5% for all of the dipped area and/or whose pinholes or voids are concentrated on one place shall be judged defect.

*3 The lead pin depth dipped into solder shall be 1.0mm away from the package edge.

*4 Terminal bending direction is shown below.



※ These test results are sampling examples from a specific lot for reference purpose only, and do not constitute any warranty or assurance in connection with the products.

5. Outgoing inspection

5.1 Inspection items

(1) Electrical characteristics

V_F , I_R , I_{DRM} , V_T , I_{FT} , R_{ISO} , V_{ISO}

(2) Appearance

5.2 Sampling method and Inspection level

LTPD sampling inspection

Confidence level : 90%

Defect	Inspection item	LTPD (%)
Major defect	Electrical characteristics(failure) Marking (Unreadable) Lead form (Deformation)	3
Minor defect	Appearance defect except the above mentioned.	50

6.2 Package specification

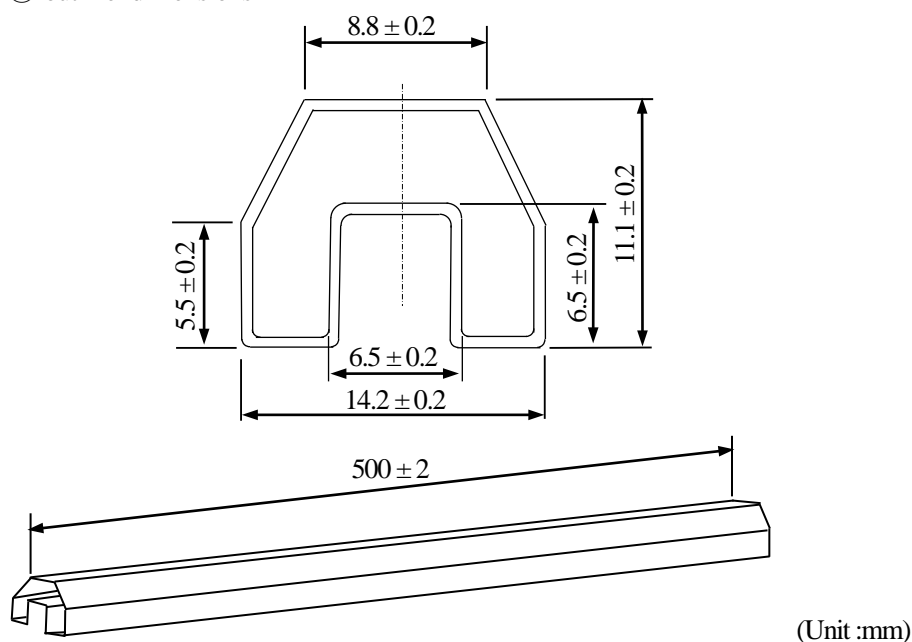
6.2.1 Package materials

No.	Name	Materials	Purposes
①	Sleeve	HIPS or ABS with preventing static electricity	Products packaged
②	Stopper	Enhanced polymer	Products fixed
③	Inner bag	Polyethylene	Packaging bag for sleeve with product
④	Sealing tape	Cellophane	Lid of inner bag
⑤	Label	Paper	Model No.,(Business dealing name),Lot No., Quantity, Country of origin , Company name and Inspection date specified
⑥	Packing case	Paper	Inner bag packaged
⑦	Cushioning material	Polyethylene	Inner bag fixed
⑧	Sealing tape	Cellophane	Lid of packingcase
⑨	Label	Paper	Model No.,(Business dealing name),Lot No., Quantity, Country of origin , Company name and Inspection date specified

6.2.2 Package method

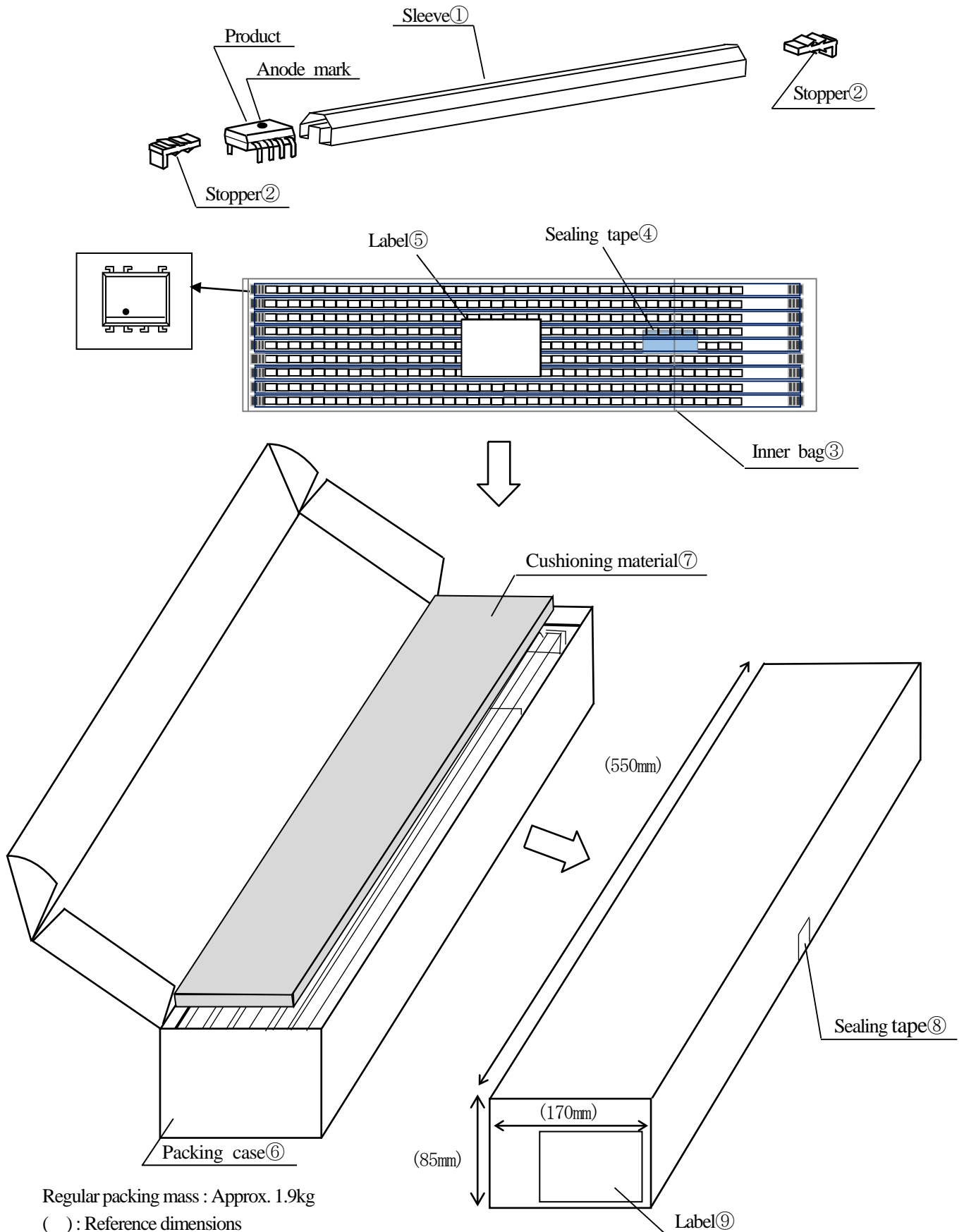
- (1) MAX. 40pcs. of products shall be packaged in a sleeve ① and both of sleeve edges shall be fixed by stoppers ②.
- (2) MAX. 25 sleeves (Product : 1,000pcs.) above shall be packaged in inner case ③. and sealed by tape ④.
- (3) The label ⑤ shall be put on the top of the inner bag.
- (4) Max 2 bags(product : 2,000pcs) above shall be packaged in packing case ⑥, and put a cushioning material ⑦ inside.
- (5) The label ⑨ shall be put on the side of the packing case.
- (6) Case shall be closed with the lid and enclosed with kraft tape ⑧.

6.2.3 Sleeve package ① outline dimensions



- Note
- 1) Thickness : 0.5 ± 0.2 mm
 - 2) Process with applying antistatic treatment.
 - 3) Unless otherwise specified tolerances shall be ± 0.5 mm.
(However except for deformation due to the stopper in sleeve.)

6.2.4 Packing outer case outline dimensions



Storage condition

Packaged products shall be stored at the temperature 5 to 30°C and the humidity 70%RH or less away from direct sunlight.